

Thyristor Surge Protector

Document: W0101092

Version: B

WEOS4-50/190AE

Features

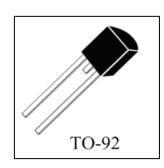
- Bi-directional crowbar transient voltage protection
- High surge capability
- High off-state impedance, Low leakage current
- Low on-state voltage
- Short-circuit failure mode











Main Application

WAYON's thyristor surge protector devices are designed to help protect sensitive telecommunication equipment from the hazards caused by lightning, power contact, and power induction. These devices enable equipment to comply with various regulatory requirements including GR 1089, ITU K.20, K.21 and K.45, IEC 60950, UL 60950, and TIA-968-A (formerly known as FCC Part 68).

Typical application including:

- Central office switching equipment, Analog and digital linecards (xDSL, T1/E1, ISDN...).
- Customer Premises Equipment (CPE) such as phones, fax machines, modems, POS terminals, PBX systems and caller ID adjunct boxes.
- Primary protection modules including Main Distribution Frames (MDF), building entrance equipment and station protection modules.
- Access network equipment such as remote terminals, line repeaters, multiplexers, cross-connects, WAN equipment, Network Interface Devices (NID).
- Data lines and security systems.
- CATV line amplifiers and power inserters.
- Sprinkler systems.

Electrical Parameters (T_{amb}=2<u>5</u>℃)

| Part Number | V_{DRM} | I _{DRM} | V _{BO} | I _{BO} | V _T | I _T | Co | Ι _Η | I _{PP} |
|----------------|-----------|------------------|------------------------|-----------------|----------------|----------------|------|----------------|-----------------|
| | Max. | Max. | Max. | Max. | Max. | Max. | Тур. | Min. | 10/1000µs |
| | V | μA | V | mA | V | Α | pF | mA | Α |
| WEOS4-50/190AE | 190 | 5 | 260 | 800 | 4 | 2.2 | 30 | 120 | 50 |

VDRM: Stand-off voltage, is measured at IDRM.

IDRM: Leakage current at VDRM.

Vво: Breakover voltage, is measured at 100V/µs.

Іво: Breakover current.

Vτ: On-state voltage.

Iт: On-state current.

Co: Off-state capacitance.

Iн: Holding current.

IPP: Peak pulse current, is a repetitive surge rating

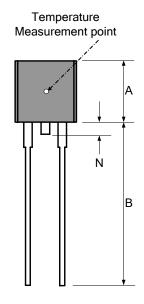
and is guaranteed for the life of the product.

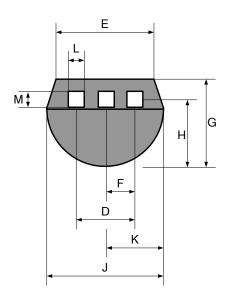
General Notes:

- All measurements are made at an ambient temperature of 25 °C. IPP applies to -40 °C through +85 °C temperature range.
- Listed WEOS4 devices are bi-directional. All electrical parameters and surge ratings apply to forward and reverse polarities.
- Special voltage (VBO and VDRM) and holding current (IH) requirements are available up on request.
- Off-state capacitance is measured at 1 MHz with a 2 V bias.

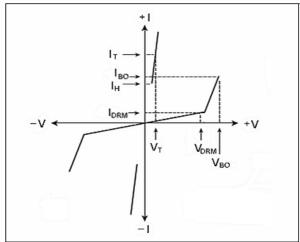
Product Dimensions

| Ref. (mm) | Min. | Max. | |
|-----------|-------|------|--|
| Α | 4.47 | 4.98 | |
| В | 12.70 | | |
| D | 2.41 | 2.67 | |
| E | 3.81 | | |
| F | 1.16 | 1.37 | |
| G | 3.43 | 3.68 | |
| Н | 2.23 | 2.44 | |
| J | 4.47 | 4.73 | |
| K | 2.23 | 2.44 | |
| L | 0.33 | 0.48 | |
| M | 0.33 | 0.43 | |
| N | | 1.52 | |

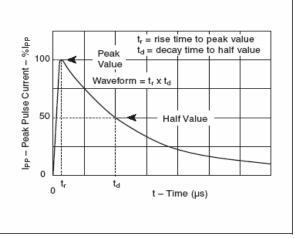




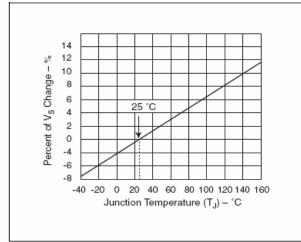
Electrical Characteristics Curves



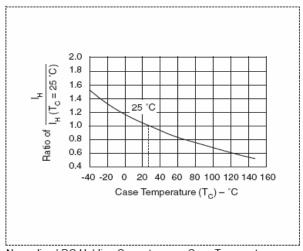




t_r x t_d Pulse Wave-form



Normalized V_S Change versus Junction Temperature



Normalized DC Holding Current versus Case Temperature

Fig. 1: Non repetitive surge peak on-state current versus overload duration.

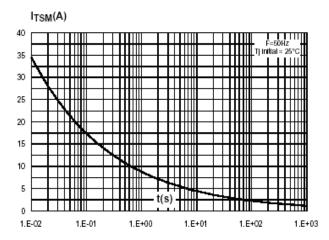


Fig. 3: Relative variation of holding current versus junction temperature.

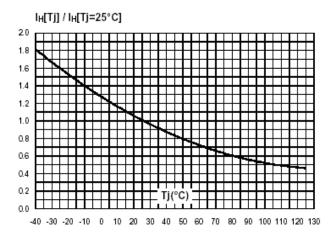


Fig. 5: Relative variation of leakage current versus reverse voltage applied (typical values).

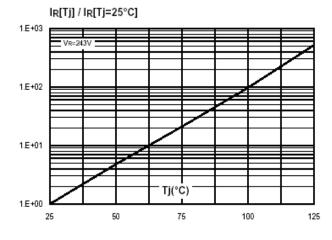


Fig. 2: On-state voltage versus on-state current (typical values)

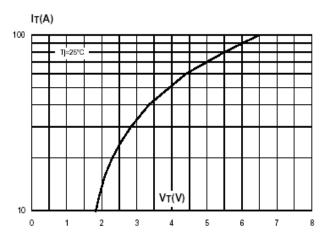


Fig. 4: Relative variation of breakover voltage versus junction temperature.

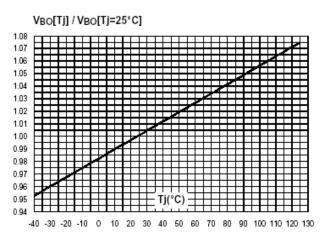
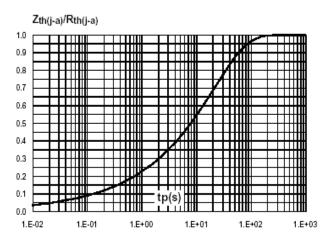


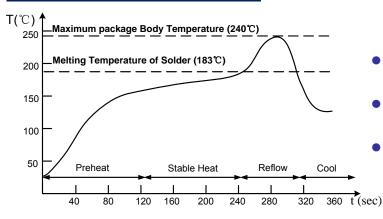
Fig. 6: Variation of thermal impedance junction to ambient versus pulse duration (Printed circuit board FR4, SCu=35µm, recommended pad layout).



Thermal Resistances

| Symbol | Parameter | Value | Unit |
|--------|------------------------------|-------------|------------------------|
| Ts | Storage temperature range | -55 to +150 | $^{\circ}$ |
| Tj | Maximum junction temperature | 150 | $^{\circ}\!\mathbb{C}$ |

Solder Reflow Recommendations



- Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- The device can be exposed to a maximum temperature of 265°C for 10 seconds.
- Devices can be cleaned using standard industry methods and solvents.

Notes: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

SGS

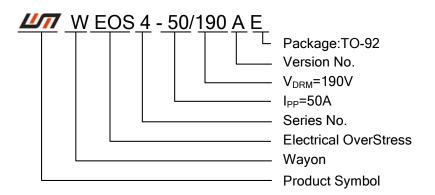
Agency Recognition

UL ,

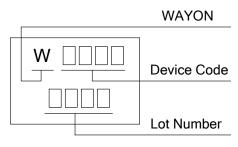
c **FL**°us

RoHS

Part Numbering System



Marking:



Package Information

Tape & Reel: 2000pcs per box.

Effectivity: Reference documents shall be the issue in effect on the date of invitation for bid.

Caution: Operation beyond the rated voltage or current may result in rupture electrical arcing or flame.